# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

# Winstar Display Co., LTD 華凌光電股份有限公司



WEB: <a href="https://www.winstar.com.tw">https://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

### **SPECIFICATION**

<b>CUSTOMER</b> :	
MODULE NO.:	WO12864A1-TFH#

AP	PR	OV	ED	BY:
Λſ		V V	עע	DI.

(FOR CUSTOMER USE ONLY)

**PCB VERSION:** 

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
5			

VERSION	DATE	REVISED PAGE NO.		SUMMARY	
G	2019/12/17		_	Precautions CD Modules	in



MODLE NO:

華凌光電股份有限公司

### **RECORDS OF REVISION**

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2011/01/21		First issue
A	2012/08/16		Modify backlight
			information.
В	2013/11/11		Remove IC information
			Correct V0-VSS
			Add Pull Tape
C	2014/08/20	40	Correct AK Pin.
D	2016/01/27		Modify Precautions in use
			of LCD Modules
			& Static electricity test
E	2016/11/18		Add FPC bending rule
F	2019/08/27		Modify Material List of
	44		Components for RoHs
G	2019/12/17		Modify Precautions in use
	\ \		of LCD Modules

### **Contents**

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

### 1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 \* 64 dot

Model serials no.

© Backlight Type: N $\rightarrow$ Without backlight T $\rightarrow$ LED, White L $\rightarrow$ LED, Full color

 $B\rightarrow EL$ , Blue green  $A\rightarrow LED$ , Amber  $J\rightarrow DIP$  LED, Blue  $D\rightarrow EL$ , Green  $R\rightarrow LED$ , Red  $K\rightarrow DIP$  LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green  $G\rightarrow$ LED, Green  $H\rightarrow$ DIP LED, Amber  $F\rightarrow$ CCFL, White  $P\rightarrow$ LED, Blue  $I\rightarrow$ DIP LED, Red

 $Y\rightarrow$ LED, Yellow Green  $X\rightarrow$ LED, Dual color  $G\rightarrow$ LED, Green  $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

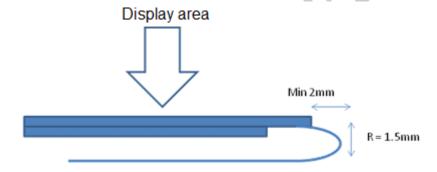
Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #: Fit in with the ROHS Directions and regulations

### 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

## 3.General Specification

Item	Dimension	Unit
Number of Characters	128 x 64 dots	_
Module dimension	60.1x 44.5 x5.01(MAX)	mm
View area	54.6 x 32.0	mm
Active area	49.89 x27.49	mm
Dot size	0.36 x0.4	mm
Dot pitch	0.39 x 0.43	mm
LCD type	FSTN Positive, Transflective (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on the same based of the same based on th	
Duty	1/65 , 1/9 Bias	
View direction	6 o'clock	
Backlight Type	LED White	
IC	ST7565P	

# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{\mathrm{OP}}$	-20	_	+70	$^{\circ}$ C
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	У
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3		V0+0.3	V

## **5.Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	2.7	3.0	3.3	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCM	$V0-V_{SS}$	Ta=25°℃	9.2	9.5	9.8	v
		Ta=70°C	_	_	<b>(</b>	y
Input High Volt.	$V_{\mathrm{IH}}$	_	0.8 V <sub>DD</sub>	_	$V_{DD}$	V
Input Low Volt.	$V_{IL}$	_	Vss	<b>├</b> (	$0.2~\mathrm{V_{DD}}$	V
Output High Volt.	$V_{\mathrm{OH}}$	I <sub>OUT</sub> =-0.5mA	$0.8\mathrm{V}_\mathrm{DD}$		$V_{ m DD}$	V
Output Low Volt.	$V_{\mathrm{OL}}$	I <sub>OUT</sub> =0.5mA	Vss	_	$0.2V_{\mathrm{DD}}$	V
Supply Current(No include  LED Backlight)	$I_{DD}$	V <sub>DD</sub> =3.0V	\\\-\\\\-\\\\\-\\\\\\\\\\\\\\\\\\\\\\\	0.10	2.0	mA

NOTE: 1) Duty ratio=1/65, Bias=1/9

2) Measured in Dots ON-state

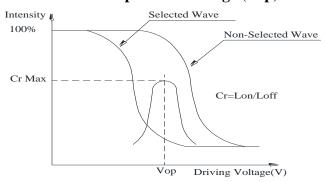
Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

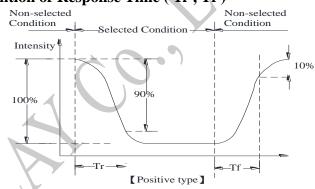
### **6.Optical Characteristics**

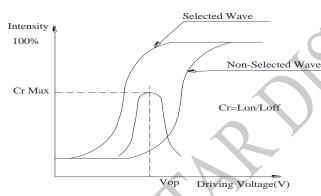
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
View Angle	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	—	250	350	ms

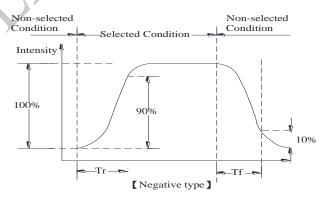
### **Definition of Operation Voltage (Vop)**

### **Definition of Response Time (Tr, Tf)**









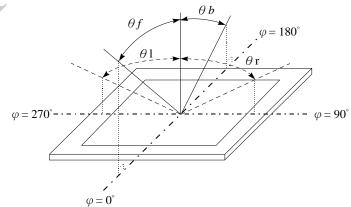
#### **Conditions:**

Operating Voltage: Vop

Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

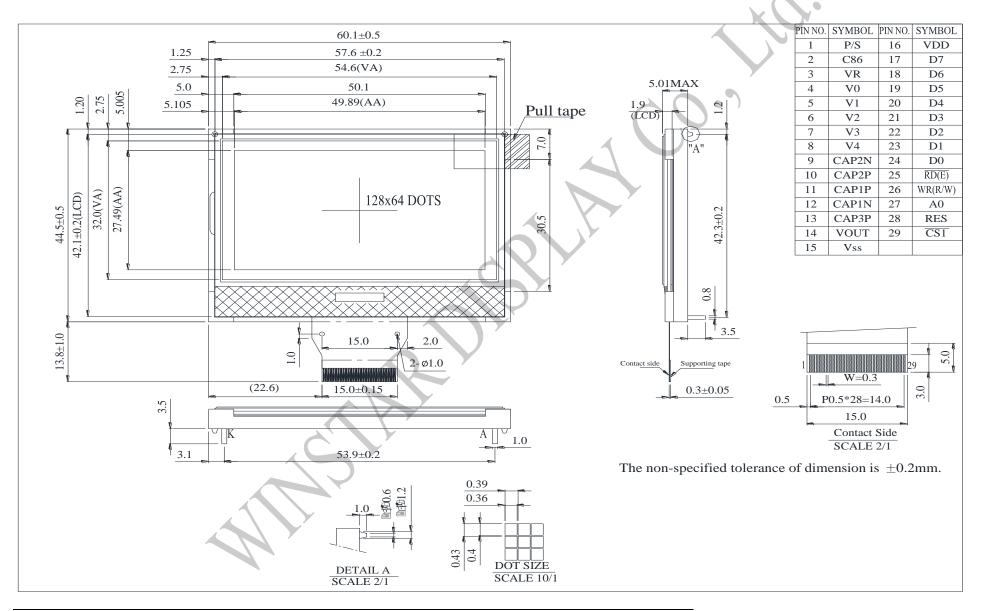
### Definition of viewing angle ( $CR \ge 2$ )

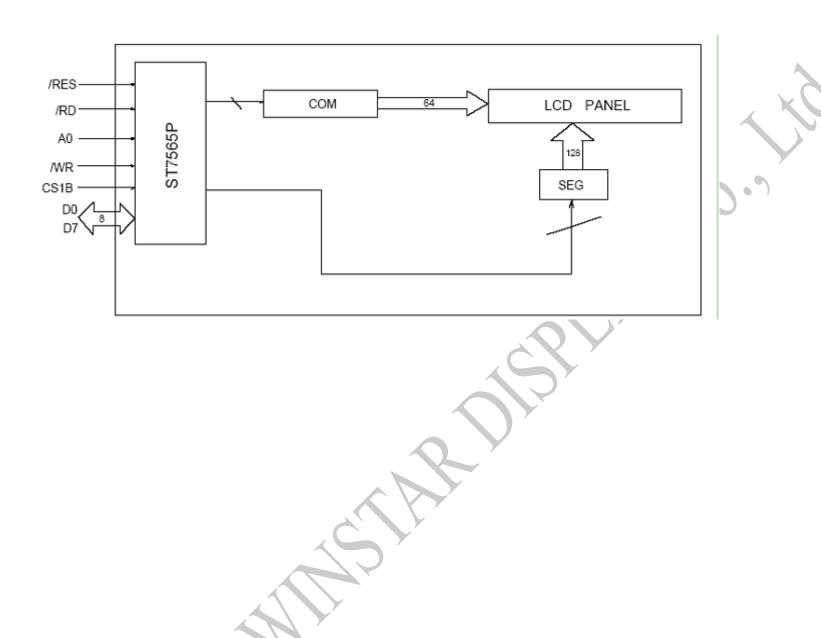


## **7.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	P/S	I	This is the parallel data input/serial data input switch terminal.
2	C86	Ι	This is the MPU interface switch terminal.
3	VR	I	Output voltage regulator terminal. Provides the voltage between VSS and V0 through a resistive voltage divider.
4~8	V0~V4	Power supply	This is a multi-level power supply for the liquid crystal drive.
9	CAP2N	О	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2P terminal.
10	CAP2P	О	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2N terminal.
11	CAP1P	О	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
12	CAP1N	О	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1P terminal.
13	CAP3P	О	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1N terminal.
14	VOUT	О	DC/DC voltage converter. Connect a capacitor between this terminal and vss or VDD
15	VSS	Power supply	Ground
16	VDD	Power supply	Power supply
17~24	D7~ D0	I/O	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard MPU data bus.
25	/RD(E)	I	The data bus is in output status when this signal is "L"
26	/WR(R/W)	I	The data bus are latched at the rising edge of the WR signal
27	A0	I	This is connect to the least significant bit of the Norman MPU address bus, and it determines whether the data bits are data or a command.
28	/RES	I	When RES is set to "L", the setting are initialized.
29	/CS1	I	This is the chip select signal.

## **8.Contour Drawing & Block Diagram**





## 9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test						
Test Item	Content of Test	Test Condition	Not e				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles					
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times					

Note1: No dew condensation to be observed.

Note 2: The function test shall be conducted after 4 hours storage at the normal  ${\bf r}$ 

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

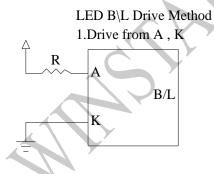
## **10.Backlight Information**

### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	64	80	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	× O
Reverse Voltage	VR	_	_	5	V	-
Luminance (Without LCD)	IV	650	820	_	CD/M <sup>2</sup>	ILED=64mA
LED Life Time					1	Iled≤64mA
(For Reference	_	_	50K	- 1	Hr.	25°C,50-60%RH,
only)						(Note 1)
Color	White			Y		

Note: The LED of B/L is drive by current only; driving voltage is only for reference To make driving current in safety area (waste current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



# 11.Inspection specification

NO	Item	Criterion				AQL
		Missing vertical	, horizonta	al segment, segmen	nt contrast defect.	
		Missing characte	er, dot or	icon.		
		Display malfund	ction.			
01	Electrical	No function or r	no display.			0.65
U1	Testing	Current consum	ption exce	eds product specif	ications.	0.03
		LCD viewing ar	ngle defect		V ()	
		Mixed product t	ypes.		4	
		Contrast defect.				
	Black or	2.1 White and h	lack snots	on display $\leq 0.25$	mm, no more than	
02	white spots on	three white or bl	_		min, no more than	2.5
02	LCD (display		•	•	or lines within 3mm	2.3
	only)	2.2 Densery spar		ore than two spots	of thies within 5hini	
		3.1 Round type	: As follow	ving drawing		
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY	
				Φ≦0.10	Accept no dense	
				$0.10 < \Phi \le 0.20$	2	
		_		$0.20 < \Phi \le 0.25$	1	2.5
				0.25<Ф	0	2.3
	LCD black	X				
	spots, white	₩_₩	<u> </u>			
03	spots, winte	• .	<b>∓</b> Y			
0.5	contamination		T			
	(non-display)	3.2 Line type : (	As follow	ing drawing)		
			Length	Width	Acceptable Q TY	
		_ /¥ w		W≦0.02	Accept no dense	
4		→ I H—	L≦3.0	$0.02 < W \le 0.03$		2.5
		1.0	L≦2.5	$0.03 < W \le 0.05$	2	2.5
				0.05 < W	As round type	

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD blac	ek spots, white spots, co	ntamination	
		Symbols Define:			
		x: Chip length y	: Chip width z: Ch	ip thickness	
		k: Seal width t:	Glass thickness a: LC	CD side length	
		L: Electrode pad length	:		
		6.1 General glass chip:			
		6.1.1 Chip on panel sur	face and crack between	panels:	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5
	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
			T		
_		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x ≤ 1/8a	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more	e chips, x is the total len	gth of each chip.	

NO	Item	Criterion			AQL
		Symbols:			
		x: Chip length y: Ch	ip width z: Ch	ip thickness	
		k: Seal width t: Gla	ass thickness a: LC	CD side length	
		L: Electrode pad length			
		6.2 Protrusion over termina	તી :		
		6.2.1 Chip on electrode page	1:		
06	Glass		Chip length ≤ 1/8a on:	$\begin{array}{c c} z \colon Chip \text{ thickness} \\ 0 < z \leqq t \end{array}$	2.5
İ		y: Chip width	x: Chip length	z: Chip thickness	
		y≤ L	$x \le 1/8a$	$0 < z \leq t$	
		⊙ If the chipped area touch			
		remain and be inspected ac		omer, the alignment mark not	
		be damaged.	it sealed by the cust	omer, the angiment mark not	
		6.2.3 Substrate protuberance	e and internal crack		
1		X			
			y: width	x: length	
			$y \le 1/3L$	$x \leq a$	
		Y.			
		085			1

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10	TCD COD	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	150	x 2	
		$X * Y \le 2mm^2$	
4		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

### **12.Material List of Components for**

### RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limi	ted va	lue is	set up a	accordi	ing to F	RoHS.	4			

- 2.Process for RoHS requirement : (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp.  $: 235\pm5^{\circ}C$ ;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

### 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Sam</u> Module Number :		Feedback Sheet Page: 1
1 · Panel Specification :		Tuge. I
1. Panel Type:	Pass	□ NG,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG ,
4. View Area:	☐ Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature :	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	☐ Pass	□ NG,
2. Frame Size:	Pass	□ NG,
3. Materal of Frame:	Pass	□ NG,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	Pass	□ NG,
6. Backlight Position:	Pass	□ NG,
7. Thickness of PCB:	Pass	□ NG ,
8. Height of Frame to PCB:	Pass	□ NG,
9. Height of Module:	Pass	□ NG,
10. Others:	☐ Pass	□ NG,
3 · Relative Hole Size:		
1. Pitch of Connector :	☐ Pass	□ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size:	☐ Pass	□ NG ,
4. Mounting Hole Type:	☐ Pass	□ NG ,
5. Others:	☐ Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	☐ Pass	□ NG ,
2. B/L Color:	☐ Pass	□ NG ,
3. B/L Driving Voltage (Refer	ence for LED 7	
4. B/L Driving Current:	☐ Pass	□ NG ,
5. Brightness of B/L:	☐ Pass	□ NG ,
6. B/L Solder Method:	☐ Pass	□ NG ,
7. Others:	☐ Pass	□ NG ,
	>> Go to	page 2 <<

odule Number:		Page: 2
5 · Electronic Characteristics of		1 450. 2
1. Input Voltage:	Pass	□ NG ,
2. Supply Current:	Pass	□ NG ,
3. Driving Voltage for LCD:	☐ Pass	□ NG ,
4. Contrast for LCD:	Pass	□ NG ,
5. B/L Driving Method:	Pass	□ NG ,
6. Negative Voltage Output:	Pass	□ NG,
7. Interface Function:	Pass	□ NG,
8. LCD Uniformity:	Pass	□ NG ,
9. ESD test:	Pass	□ NG ,
10. Others:	Pass	□ NG,
6 · Summary :		